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	•	JUL 1 1 2001
Docket No.:		\ sat
	DECLARATION AND POWER OF ATTORI	VE YMENT TRACES

As a below named inventor, I hereby of	eclare that:		
My residence, post office and citizensh	ip are as stated below next to my name,		
	sole inventor (if only one name is listed belo claimed and for which a patent is sought on		
[X] is attached hereto[] was filed or was amended on	as Application S	Serial No.	_ and
I hereby state that I have reviewed and any amendment referred to above.	understand the contents of the above ident	ified specification, including the clai	ms, as amended by
I acknowledge the duty to disclose info Federal Regulations, Section 1.56(a).	ormation which is known to me to be materi	ial to patentability in accordance wit	h Title 37, Code of
or 365(a) of any PCT international app and have also identified below, by chec	under 35 U.S.C. 119(a)-(d) or 365 (b) of any lication which designated at least one count king the box, any foreign application for pa that of the application on which priority is c	ry other than the United States of A tent or inventor's certificate, or of a	merica, listed below
Prior Foreign Application(s): Number	Country	Foreign Filing Date Month/Day/Year	
P99-52534	Korea	11/24/1999	<u> </u>
P99-52535	Korea	11/24/1999	<u>ෆ්</u>
P99-52536	Korea	11/24/1999	
I hereby claim the benefit under 35 U.	S.C. 119(e) of any United States provisional	application(s) listed below.	9 - 5
Application Number(s):	Filing Date (Month/D	ay/Year)	12 26) MAIL ROO
the United States of America, listed be prior United States or PCT internation to disclose information which is mater	S.C. 120 of any United States application(s), low and, insofar as the subject matter of eac al application in the manner provided by the lal to patentability as defined in 37 CFR 1.56 CT international filing date of this application	ch of the claims of this application is e first paragraph of 35 U.S.C. 112, I 6 which became available between th	application designating not disclosed in the acknowledge the duty
Prior U. S. Application or PCT Parent Number	Filing Date (Month/Day/Year)	Parent Patent Number (i	f applicable)
· ·	de herein of my own knowledge are true and ese statements were made with the knowled		

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vazquez, Registration No. 38,647; Michael J. Cornelison, Registration No. 40,395; and Stuart I. Smith, Registration No. 42,159; and Carol L. Druzbick, Registration No. 40,287, all of

FLESHNER & KIM P. O. Box 221200 Chantilly, Virginia 20153-1200

with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

**************************************	********
Full name of joint inventor(s): PARK, Hun Gun	
Inventor's signature: Park, Hun Gun Dat	e: 2000 . 11. 20
Residence: #406 Ga-dong, Woosuk Apartment, 2 ,Gongdan-dong, Kumi-shi, Korea	
Citizenship: Republic of Korea	
Post Office Address: Same as above	
**************************************	********
Full name of joint inventor(s):	
Inventor's signature: Dat	e:
Residence:	
Citizenship:	
Post Office Address:	
**************************************	*********
Full name of joint inventor(s):	
Inventor's signature: Dat	e:
Residence:	
Citizenship:	
Post Office Address:	
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Full name of joint inventor(s):	
Full name of joint inventor(s): Inventor's signature: Date of joint inventor(s):	e:
	e:
Inventor's signature: Dat	e: